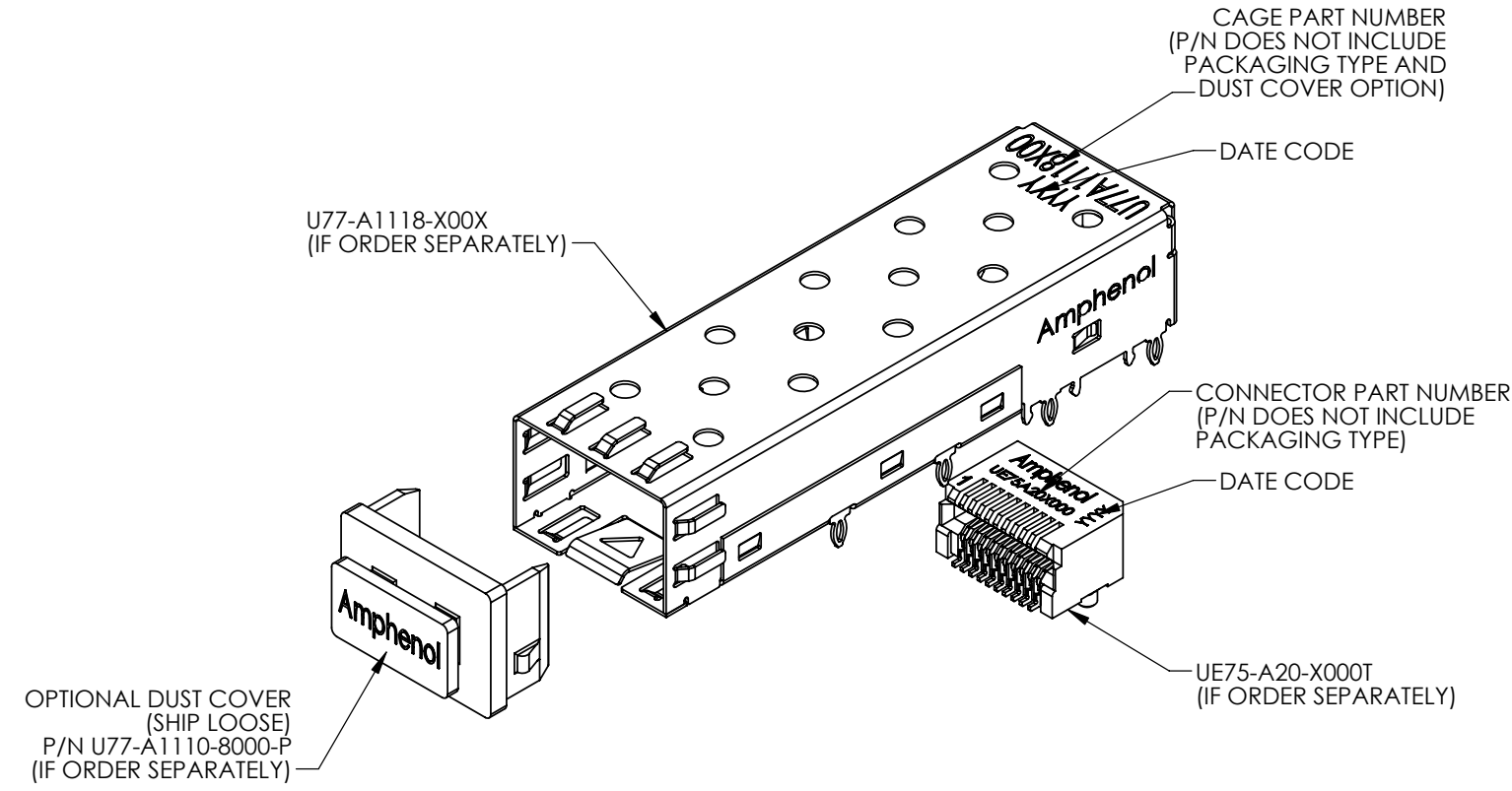


REVISIONS				
REV.	ECN/E-R	DESCRIPTION	DATE	APPROVED
B		CUSTOMER DRAWING	2006/04/05	J.SI
C		UPDATED	2006/08/09	
D		UPDATED	2007/01/02	



AMPHENOL PART NUMBER CONFIGURATION:

UE78 - A 1 1 1 8 - 0 X X X X

OPTIONAL DUST COVER
 0 - WITHOUT DUST COVER
 D - WITH DUST COVER (SHIP LOOSE)

PLATING OPTIONS FOR CONNECTOR
 2 - 30µ" GOLD PLATING ON MATING AREA
 GOLD FLASH ON TERMINATION
 3 - 30µ" GOLD PLATING ON MATING AREA
 150-300µ" MATTE TIN ON TERMINATION
 5 - 15µ" GOLD PLATING ON MATING AREA
 GOLD FLASH ON TERMINATION
 6 - 15µ" GOLD PLATING ON MATING AREA
 150-300µ" MATTE TIN ON TERMINATION

PACKAGING OPTIONS
 T - TAPE AND REEL PACKAGING
 FOR BOTH CONNECTORS AND
 CAGES
 H - TAPE AND REEL FOR
 CONNECTORS TRAY FOR
 CAGES

PLATING OPTIONS FOR CAGE
 1 - TIN
 2 - NICKEL

MATERIAL (RoHS COMPLIANCE):

CAGE:
 COPPER ALLOY
 PLATING OPTION 1: 100µ" [2.54 µm] TIN PLATING OVER
 50 µ" (1.27 µm) NICKEL UNDER PLATING.
 PLATING OPTION 2: 100µ" [2.54 µm] NICKEL PLATING
 (NOT FOR SOLDER PINS).
DUST COVER
 THERMOPLASTIC, COLOR BLACK.
PACKAGING:
 TAPE AND REEL OR TRAY PACKAGING.
 TEMPERATURE RANGE: -40 °C TO +85 °C

CONNECTOR:

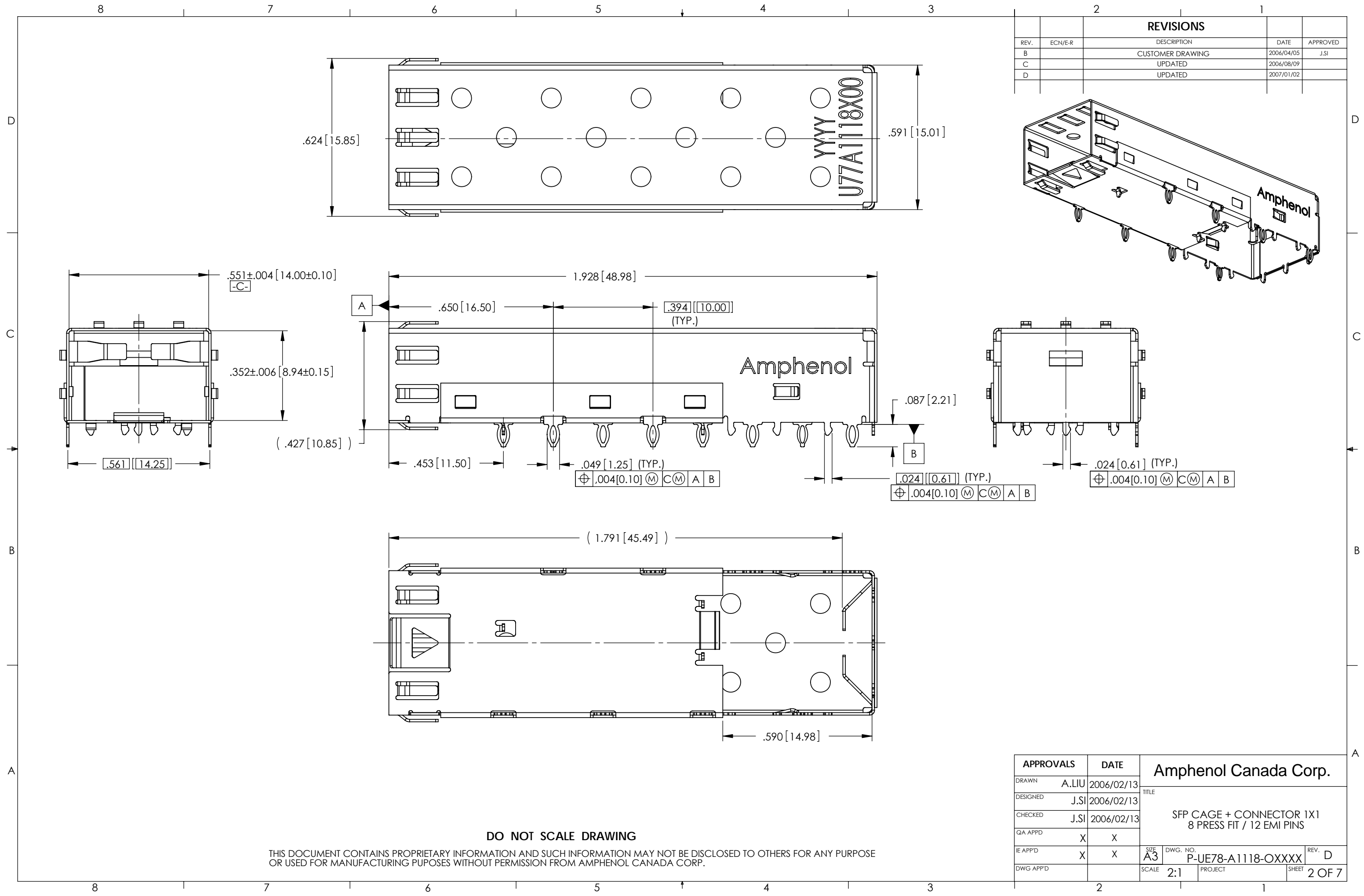
PLASTIC HOUSING:
 HIGH TEMPERATURE RESISTANT NYLON FLAMMABILITY RATING UL94V-0.
CONTACTS:
 PHOSPHOR BRONZE
 PLATING OPTION 2: 30µ" [0.76 µm] GOLD ON MATING AREA AND 2 µ"
 (0.05 µm) GOLD FLASH PLATING ON TERMINATION OVER
 50µ"[1.27µm] NICKEL UNDER LAYER.
 PLATING OPTION 3: 30µ" [0.76 µm] GOLD ON MATING AREA AND
 150-300 µ" (3.81-7.62 µm) LOW WHISKER MATTE TIN PLATING
 ON TERMINATION OVER 50µ" [1.27 µm] NICKEL UNDER LAYER.
 PLATING OPTION 5: 15µ" GOLD PLATING ON MATING AREA
 GOLD FLASH ON TERMINATION
 PLATING OPTION 6: 15µ" GOLD PLATING ON MATING AREA
 150-300µ" (3.81-7.62 µm) MATTE TIN ON TERMINATION

PACKAGING:
 TAPE AND REEL.
 TEMPERATURE RANGE: -40 °C TO +85 °C

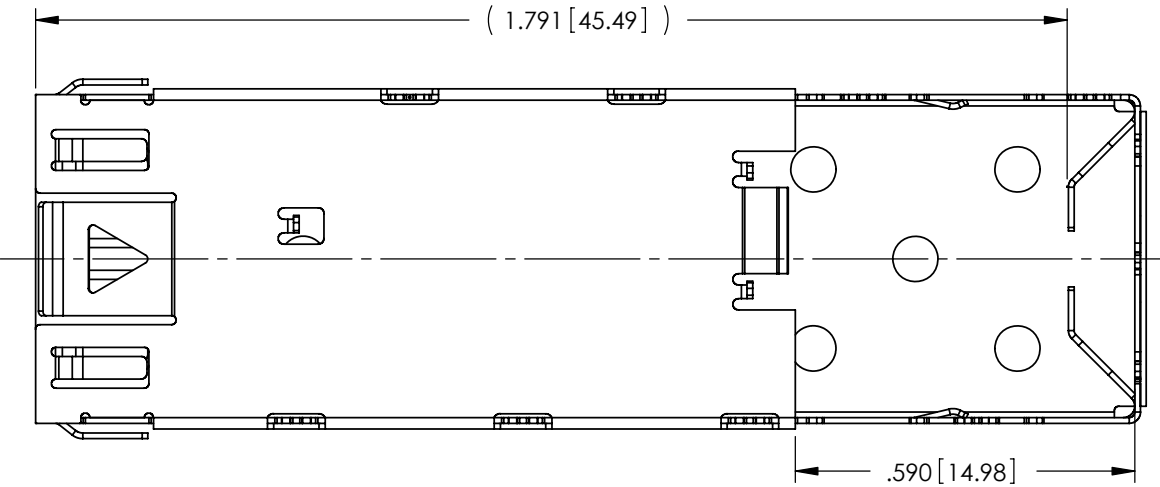
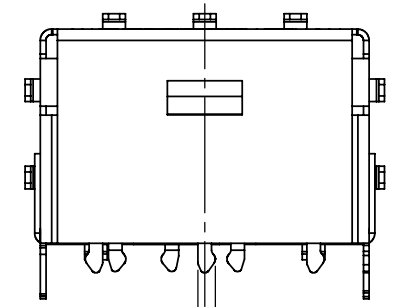
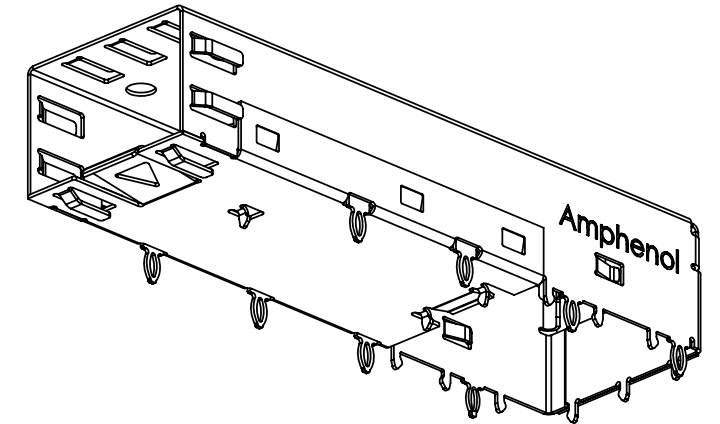
DO NOT SCALE DRAWING

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APPROVALS		DATE	Amphenol Canada Corp.		
DRAWN	A.LIU	2006/02/13			
DESIGNED	J.SI	2006/02/13	TITLE SFP CAGE + CONNECTOR 1X1 8 PRESS FIT / 12 EMI PINS		
CHECKED	J.SI	2006/02/13			
QA APPD	X	X			
IE APPD	X	X	SIZE A3	DWG. NO. P-UE78-A1118-0XXXX	REV. D
DWG APPD			SCALE 2:1	PROJECT	SHEET 1 OF 7



REVISIONS				
REV.	ECN/E-R	DESCRIPTION	DATE	APPROVED
B		CUSTOMER DRAWING	2006/04/05	J.SI
C		UPDATED	2006/08/09	
D		UPDATED	2007/01/02	

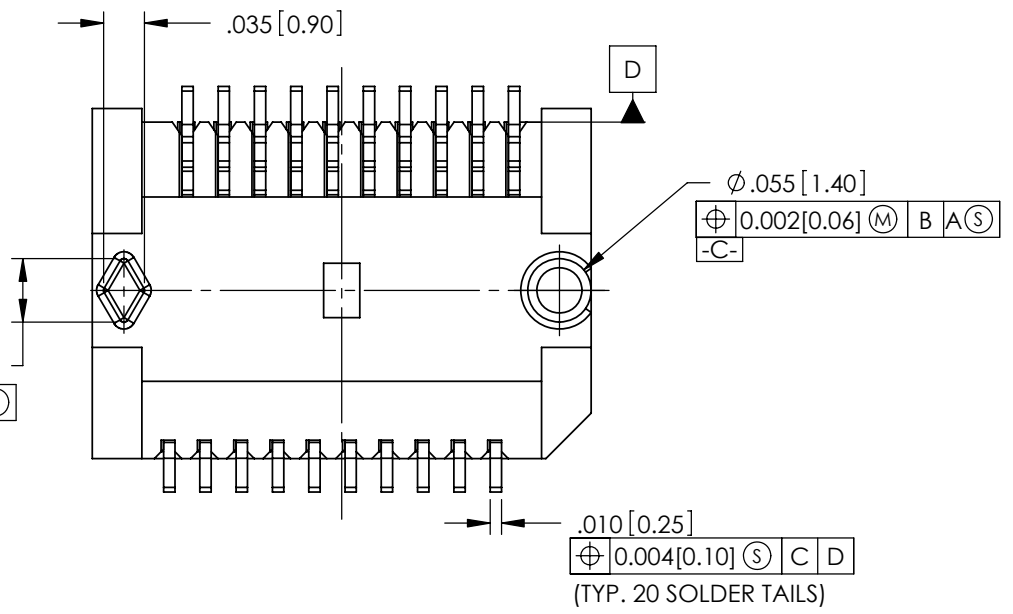
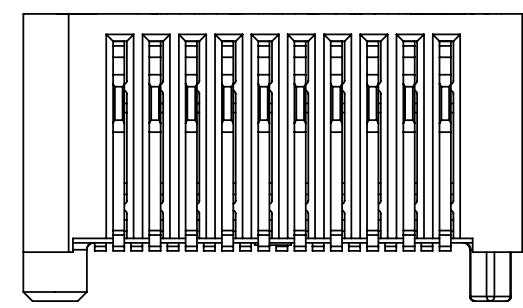
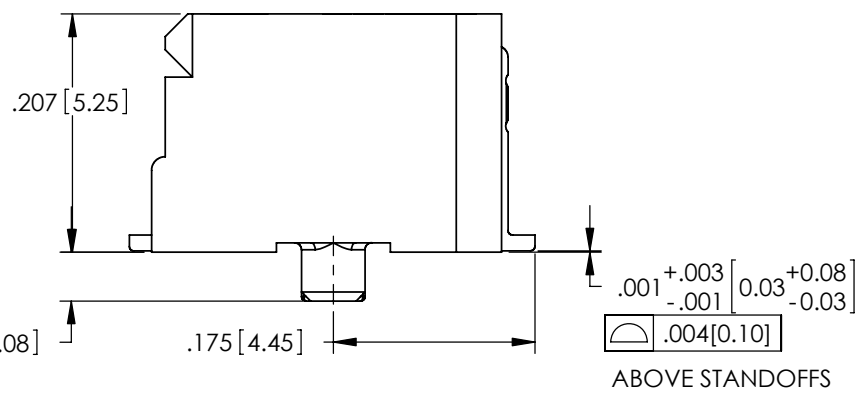
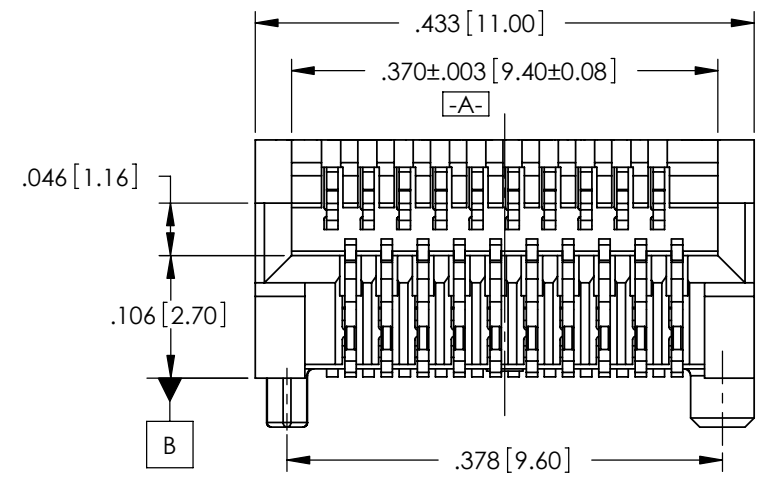
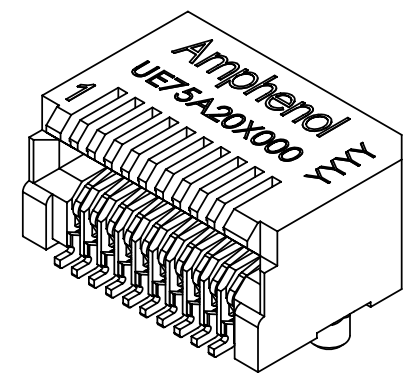
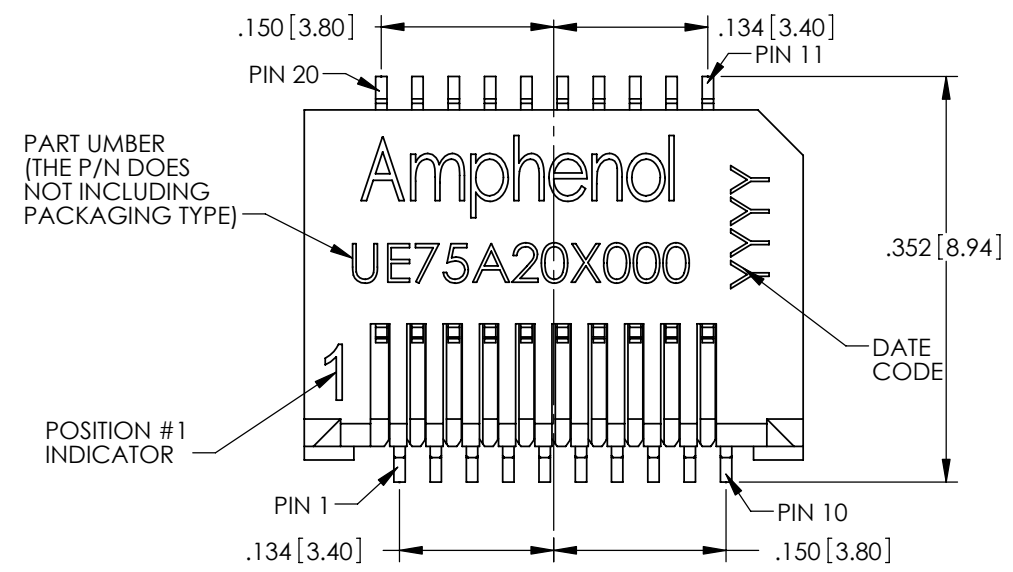


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DRAWN	A.LIU	2006/02/13	TITLE		
DESIGNED	J.SI	2006/02/13	SFP CAGE + CONNECTOR 1X1 8 PRESS FIT / 12 EMI PINS		
CHECKED	J.SI	2006/02/13	REV. D		
QA APPD	X	X	SIZE	DWG. NO.	REV.
IE APPD	X	X	A3	P-UE78-A1118-OXXXX	D
DWG APPD			SCALE	PROJECT	SHEET
			2:1		2 OF 7

REVISIONS				
REV.	ECN/E-R	DESCRIPTION	DATE	APPROVED
B		CUSTOMER DRAWING	2006/04/05	J.SI
C		UPDATED	2006/08/09	
D		UPDATED	2007/01/02	



⊕ 0.002 [0.06] (M) B A (S) C (S)

⊕ 0.055 [1.40]
⊕ 0.002 [0.06] (M) B A (S)
-C-

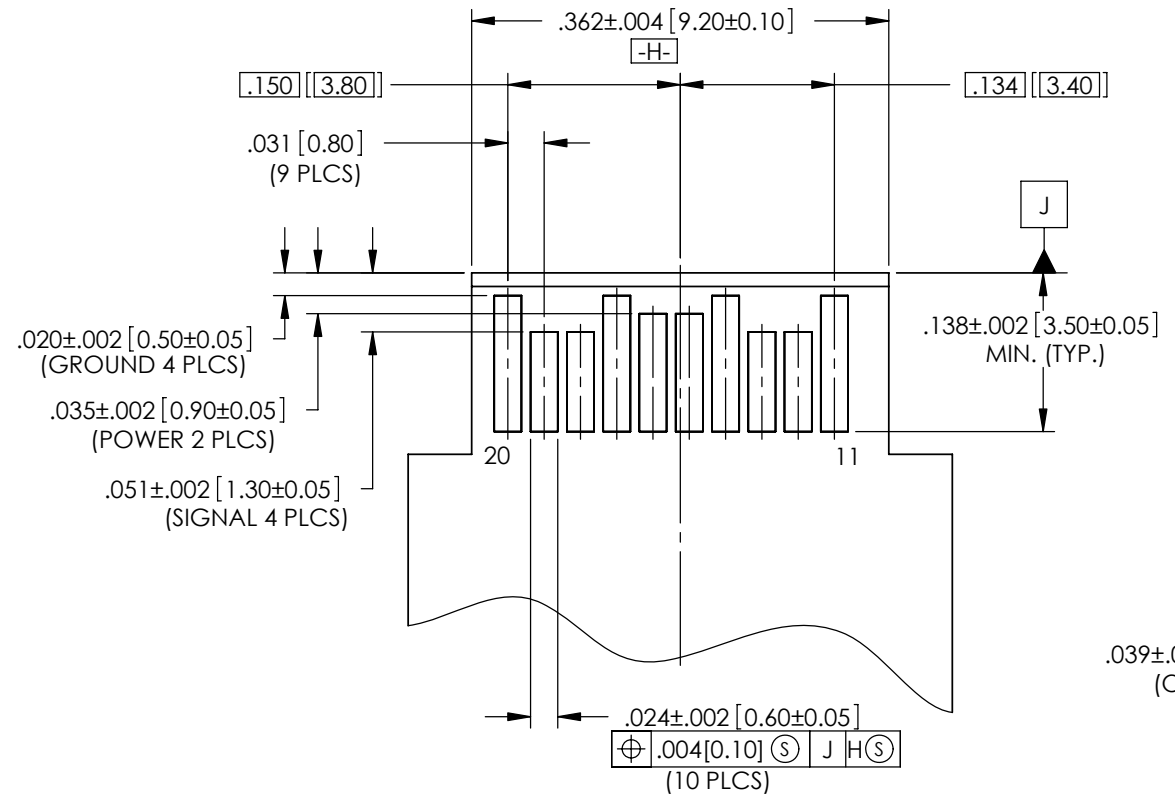
⊕ 0.010 [0.25]
⊕ 0.004 [0.10] (S) C D
(TYP. 20 SOLDER TAILS)

DO NOT SCALE DRAWING

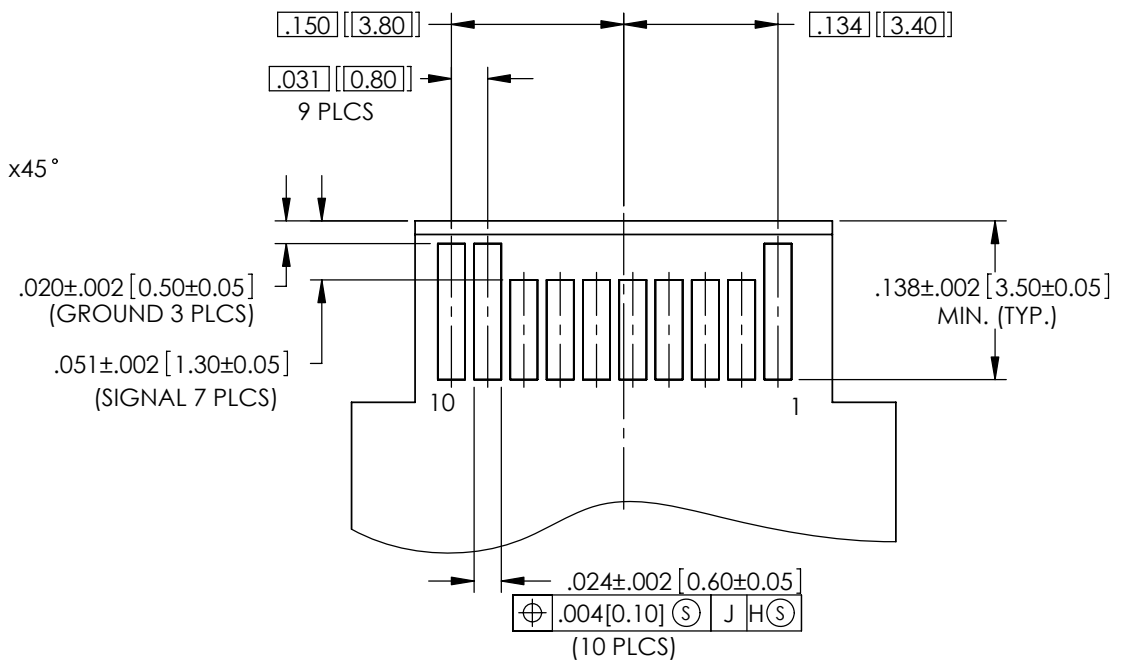
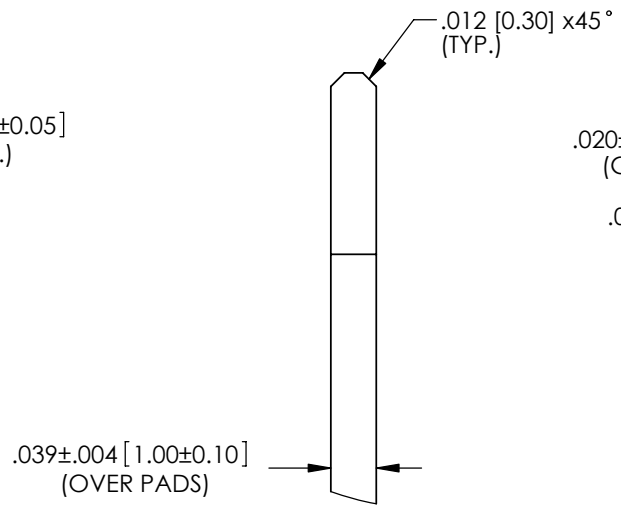
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DESIGNED	J.SI	2006/02/13	SFP CAGE + CONNECTOR 1X1 8 PRESS FIT / 12 EMI PINS		
CHECKED	J.SI	2006/02/13			
QA APPD	X	X			
IE APPD	X	X	SIZE A3	DWG. NO. P-UE78-A1118-0XXXX	REV. D
DWG APPD			SCALE 4:1	PROJECT	SHEET 3 OF 7

REVISIONS				
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B		CUSTOMER DRAWING	2006/04/05	
C		UPDATED	2006/08/09	
D		UPDATED	2007/01/02	



TOP VIEW OF BOAD



BOTTOM VIEW OF BOAD

RECOMMENDED LAYOUT DETAIL
MATING TRANSCEIVER PCB

DO NOT SCALE DRAWING

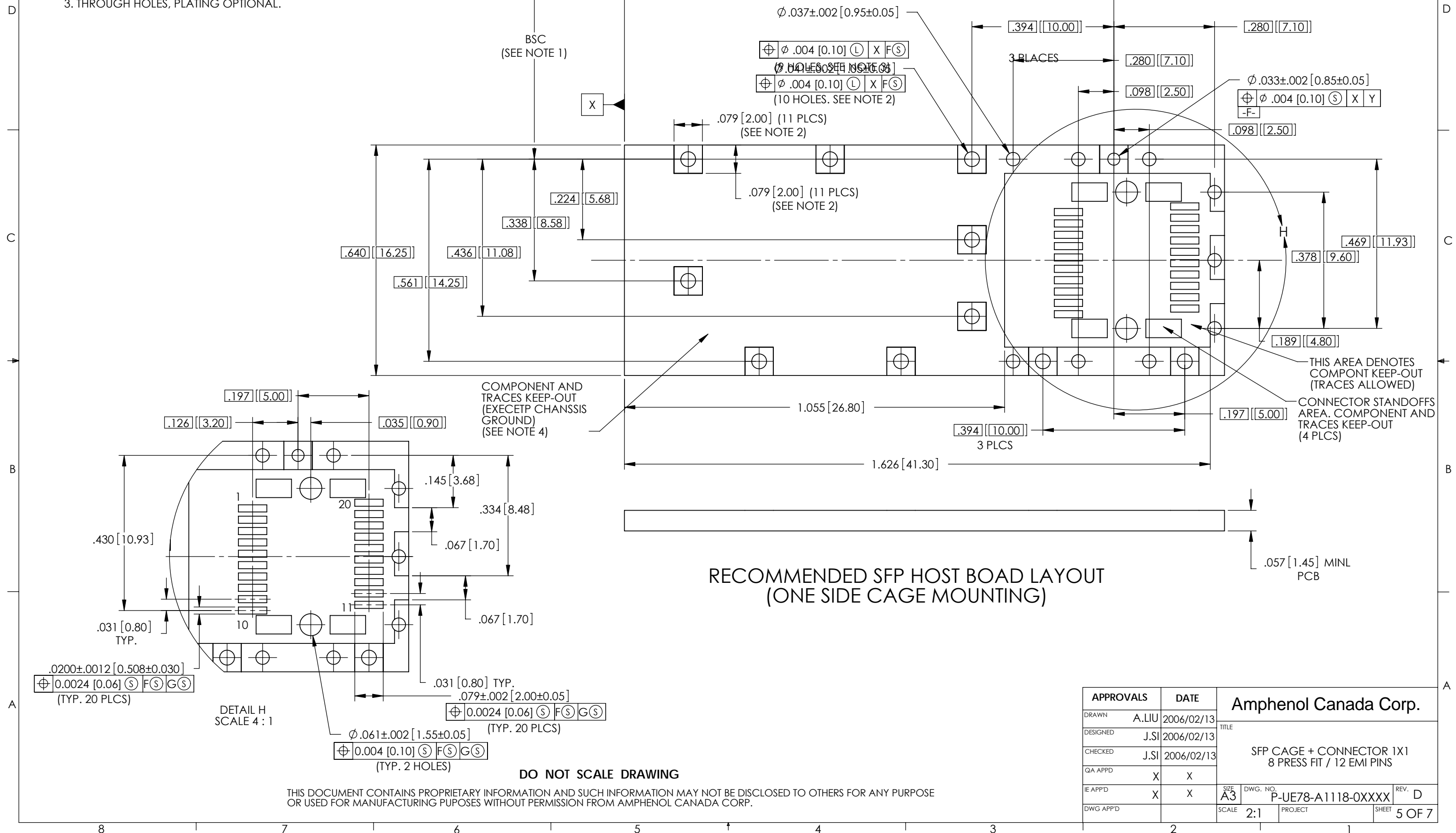
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DESIGNED	J.SI	2006/02/13			
CHECKED	J.SI	2006/02/13			
QA APPD	X	X			
IE APPD	X	X	SIZE A3	DWG. NO. P-UE78-A1118-0XXXX	REV. D
DWG APPD			SCALE 4:1	PROJECT	SHEET 4 OF 7

REVISIONS

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C		UPDATED	2006/08/09	
D		UPDATED	2007/01/02	

NOTES;
 1. DATUM AND BASIC DIMENTIONS ESTABLISHED BY CUSTOMER
 2. PADS AND VIAS ARE CHASSIS GROUND, 11 PLACES.
 3. THROUGH HOLES, PLATING OPTIONAL.



BSC
(SEE NOTE 1)

$\phi .004 [0.10] \text{ (L) X F (S)}$
 $\phi .004 [0.10] \text{ (L) X F (S)}$
 (10 HOLES. SEE NOTE 2)

$\phi .033 \pm .002 [0.85 \pm 0.05]$
 $\phi .004 [0.10] \text{ (S) X Y}$
 -F-

COMPONENT AND TRACES KEEP-OUT (EXCEPT CHASSIS GROUND) (SEE NOTE 4)

THIS AREA DENOTES COMPONENT KEEP-OUT (TRACES ALLOWED)
 CONNECTOR STANDOFFS AREA. COMPONENT AND TRACES KEEP-OUT (4 PLCS)

RECOMMENDED SFP HOST BOARD LAYOUT (ONE SIDE CAGE MOUNTING)

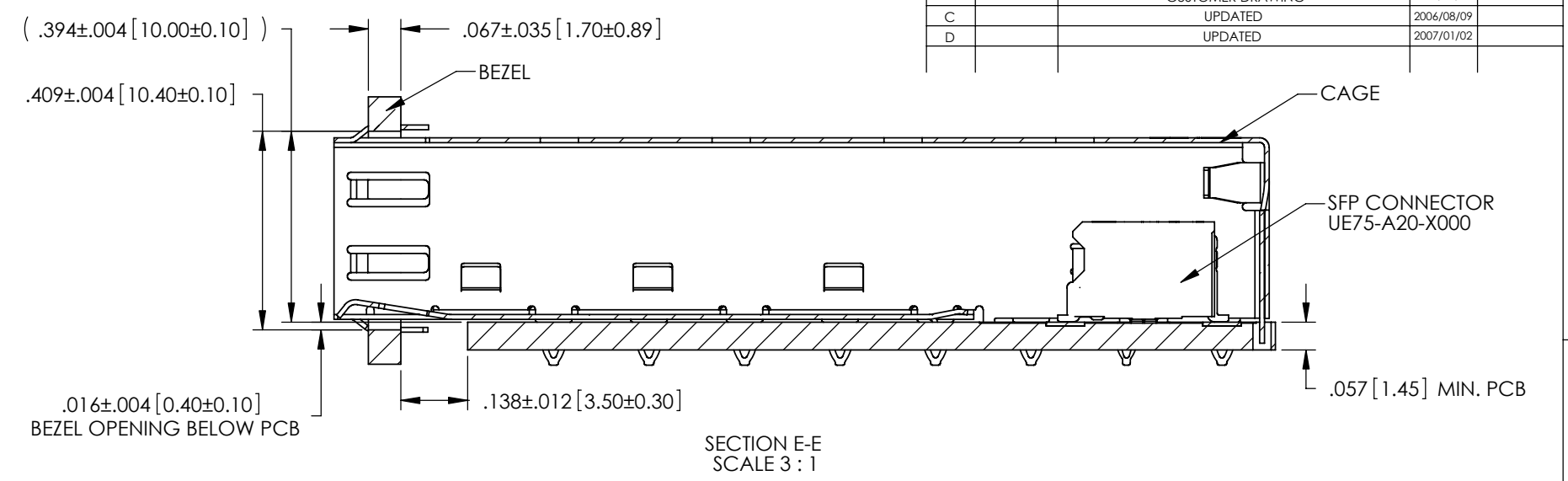
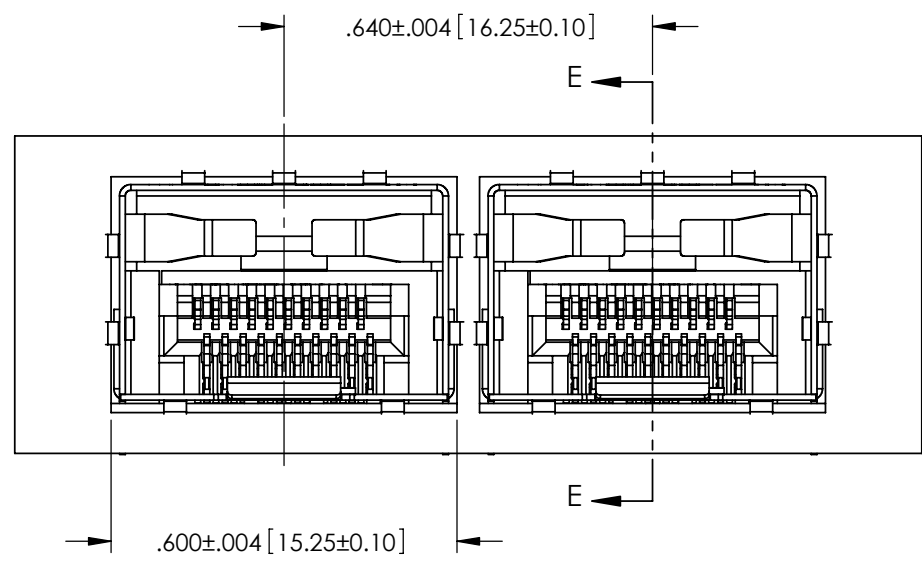
DETAIL H
SCALE 4 : 1

DO NOT SCALE DRAWING

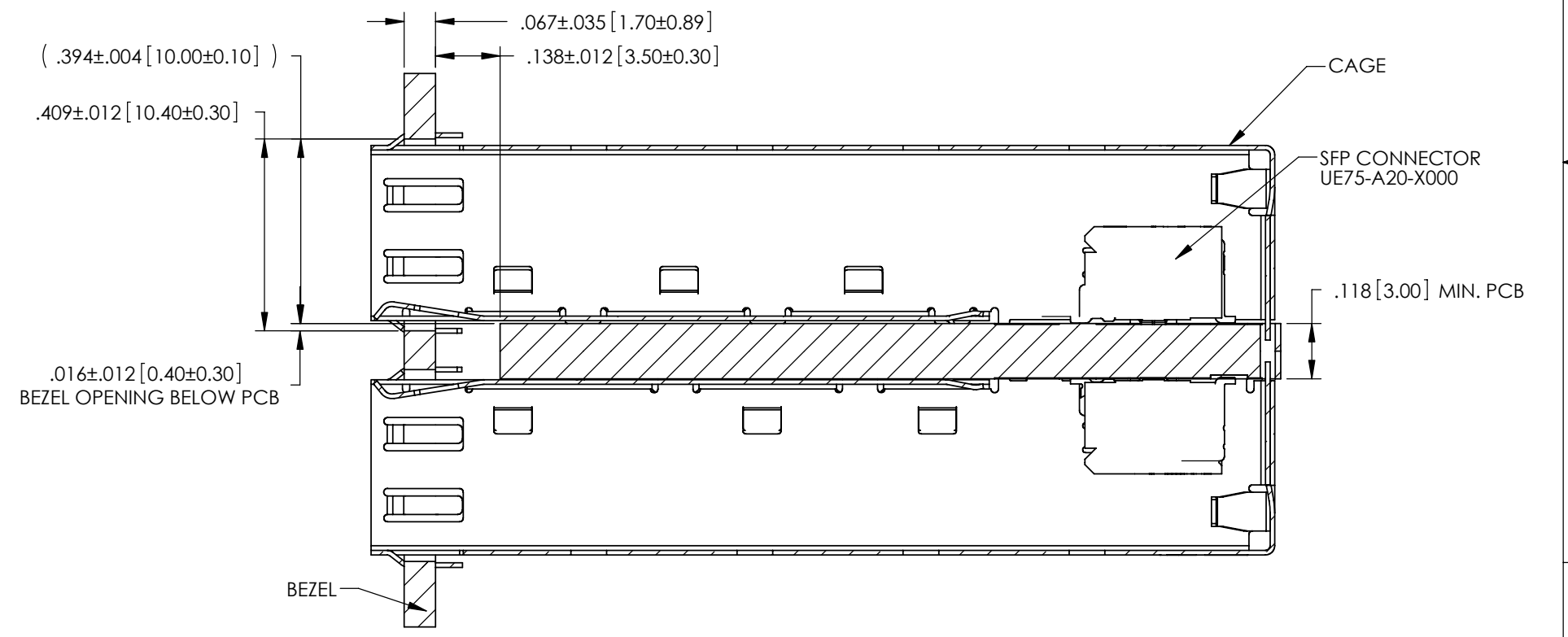
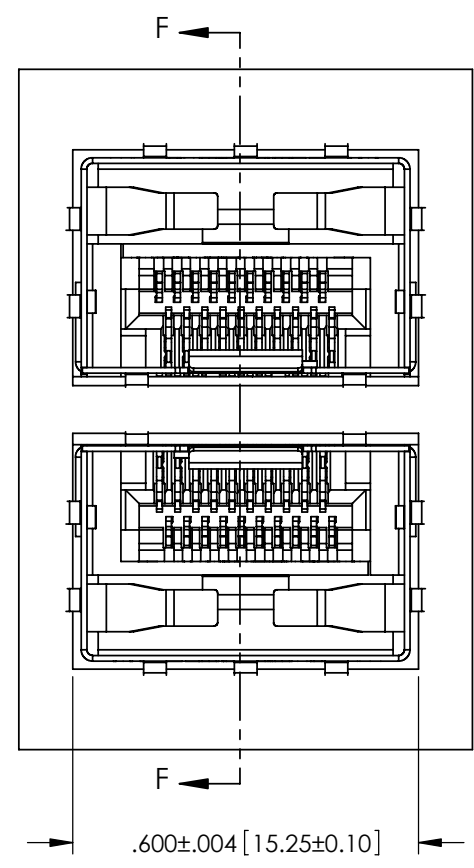
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CHECKED	J.SI	2006/02/13	SIZE	DWG. NO.
QA APPD	X	X	A3	P-UE78-A1118-0XXXX
IE APPD	X	X	SCALE	REV. D
DWG APPD			2:1	PROJECT SHEET 5 OF 7

REVISIONS				
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C		UPDATED	2006/08/09	
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RECOMMENDED BEZEL DESIGN
(ONE SIDE CAGE MOUNTING)



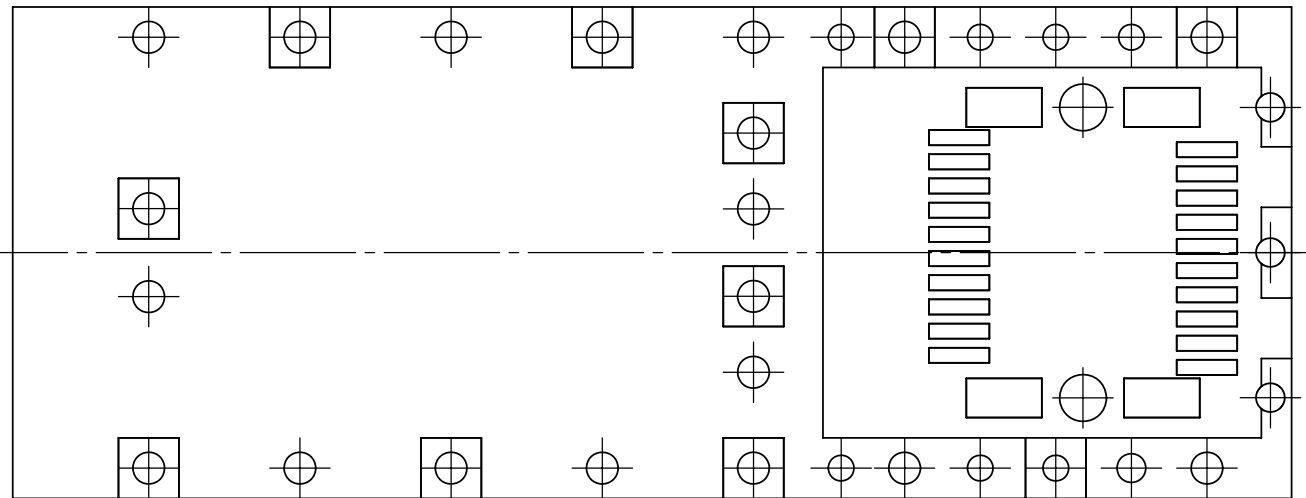
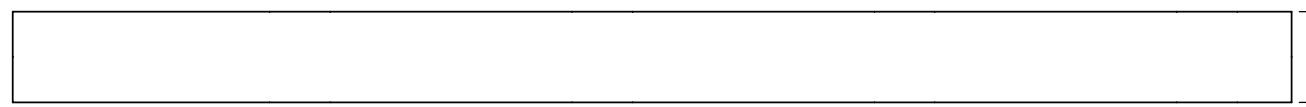
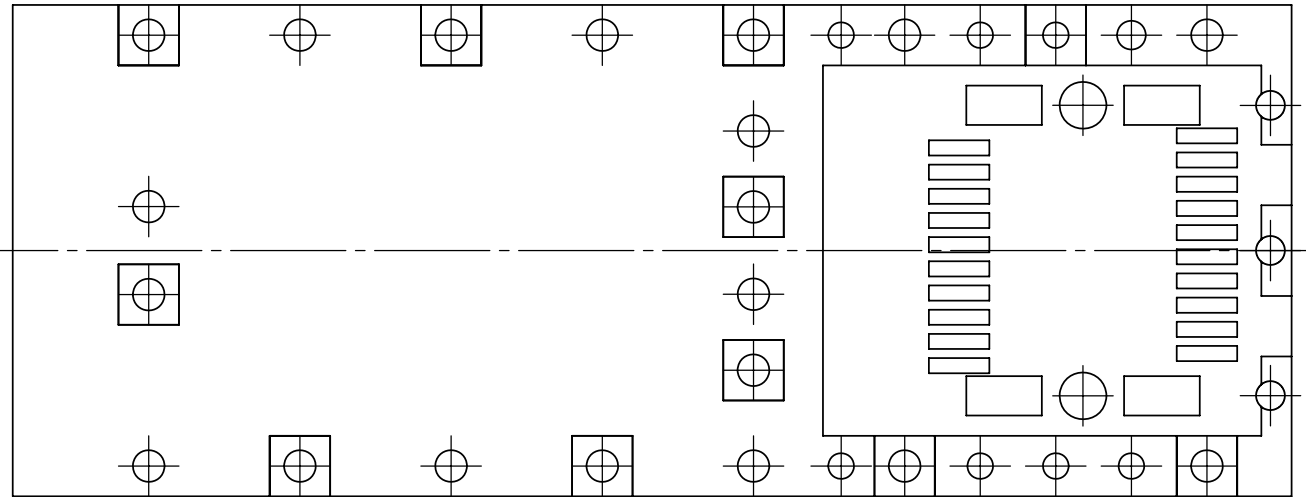
RECOMMENDED BEZEL DESIGN
(BELLY TO BELLY CAGE MOUNTING)

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CHECKED	J.SI	2006/02/13	REV. D		
QA APPD	X	X	SIZE A3	DWG. NO. P-UE78-A1118-0XXXX	REV. D
IE APPD	X	X	SCALE 2:1	PROJECT	SHEET 6 OF 7
DWG APPD					

REVISIONS				
REV.	ECN/E-R	DESCRIPTION	DATE	APPROVED
B		CUSTOMER DRAWING	2006/04/05	
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D		UPDATED	2007/01/02	



RECOMMENDED SFP HOST BOARD LAYOUT
(BELLY TO BELLY CAGE MOUNTING)

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DESIGNED	J.SI	2006/02/13			
CHECKED	J.SI	2006/02/13			
QA APPD	X	X			
IE APPD	X	X	SIZE A3 DWG. NO. P-UE78-A1118-0XXXX SCALE 2:1	PROJECT SHEET 7 OF 7	REV. D

Данный компонент на территории Российской Федерации

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<http://moschip.ru/get-element>

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

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